

P-Channel Enhancement Mode Power MOSFET

Description

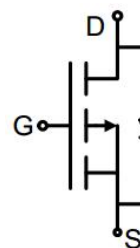
The GT750P10K uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.

General Features

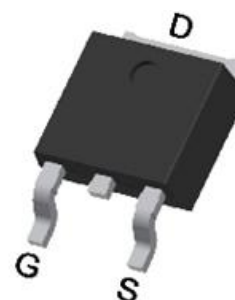
- V_{DS} -100V
- I_D (at $V_{GS} = -10V$) -24A
- $R_{DS(ON)}$ (at $V_{GS} = -10V$) < 75m Ω
- $R_{DS(ON)}$ (at $V_{GS} = -4.5V$) < 90m Ω
- 100% Avalanche Tested
- RoHS Compliant

Application

- Power switch
- DC/DC converters



Schematic diagram



TO-252

Ordering Information

Device	Package	Marking	Packaging
GT750P10K	TO-252	GT750P10	2500pcs/Reel

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-100	V
Continuous Drain Current	I_D	-24	A
		-15	
Pulsed Drain Current (note1)	I_{DM}	-96	A
Gate-Source Voltage	V_{GS}	± 20	V
Power Dissipation	P_D	79	W
Single pulse avalanche energy (note2)	E_{AS}	81	mJ
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	$^\circ\text{C}$

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	50	$^\circ\text{C/W}$
Maximum Junction-to-Case	R_{thJC}	1.58	$^\circ\text{C/W}$

Specifications T _J = 25°C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-100	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -100V, V _{GS} = 0V	--	--	-1	μA
Gate-Source Leakage	I _{GSS}	V _{GS} = ±20V	--	--	±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-1.0	-1.9	-2.5	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = -10V, I _D = -20A	--	59	75	mΩ
		V _{GS} = -4.5V, I _D = -20A	--	72	90	
Forward Transconductance	g _{FS}	V _{DS} = -5V,I _D = -20A	--	22	--	S
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = -50V, f = 1.0MHz	--	1950	--	pF
Output Capacitance	C _{oss}		--	155	--	
Reverse Transfer Capacitance	C _{rss}		--	20	--	
Total Gate Charge	Q _g	V _{DD} = -50V, I _D = -20A, V _{GS} = -10V	--	29	--	nC
Gate-Source Charge	Q _{gs}		--	5	--	
Gate-Drain Charge	Q _{gd}		--	3	--	
Turn-on Delay Time	t _{d(on)}	V _{DD} = -50V, I _D = -20A, R _G = 6Ω	--	13	--	ns
Turn-on Rise Time	t _r		--	39	--	
Turn-off Delay Time	t _{d(off)}		--	100	--	
Turn-off Fall Time	t _f		--	105	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I _S	T _C = 25°C	--	--	-24	A
Body Diode Voltage	V _{SD}	T _J = 25°C, I _{SD} = -20A, V _{GS} = 0V	--	--	-1.2	V
Reverse Recovery Charge	Q _{rr}	I _F = -20A, V _{GS} = 0V di/dt=-100A/us	--	280	--	nC
Reverse Recovery Time	T _{rr}		--	104	--	ns

Notes

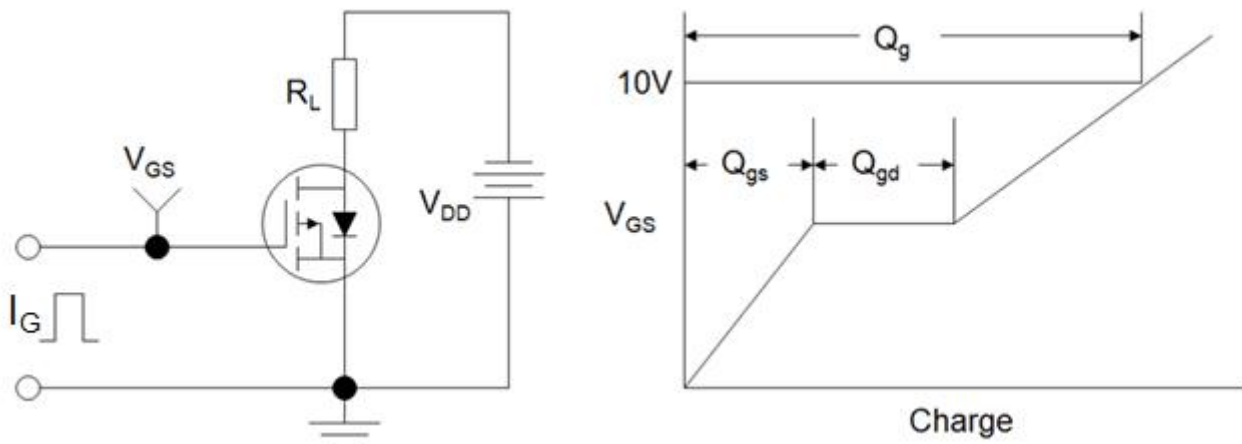
1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. EAS condition : $T_J = 25^{\circ}\text{C}$, $V_{DD} = 50V$, $V_{GS} = 10V$, $L = 0.5mH$, $R_g = 25\Omega$

The table shows the minimum avalanche energy, which is 225mJ when the device is tested until failure

3. Identical low side and high side switch with identical R_G

Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

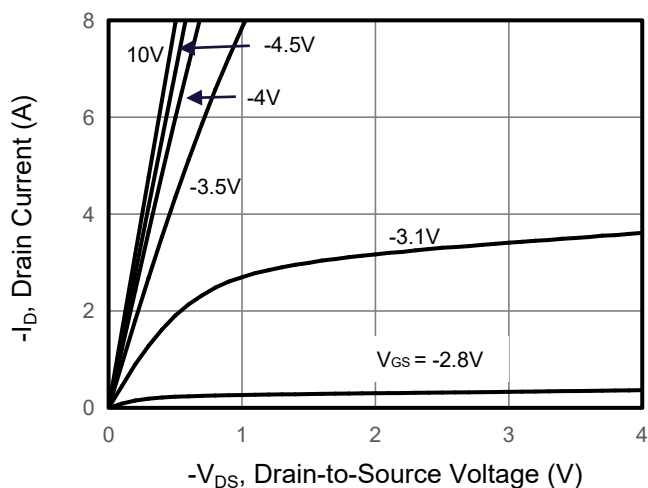


Figure 2. Transfer Characteristics

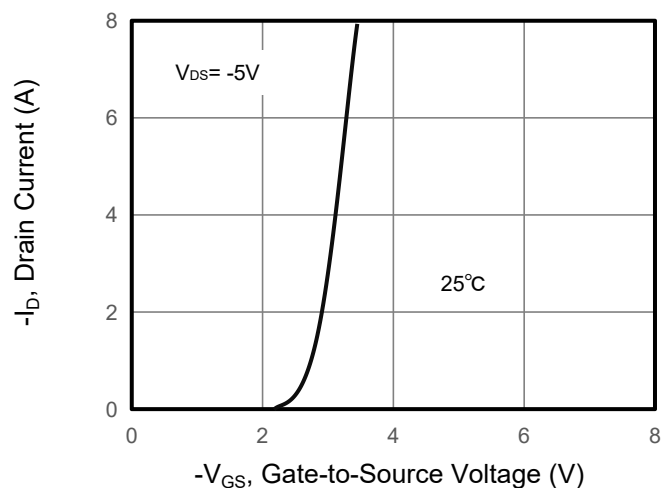


Figure 3. Drain Source On Resistance

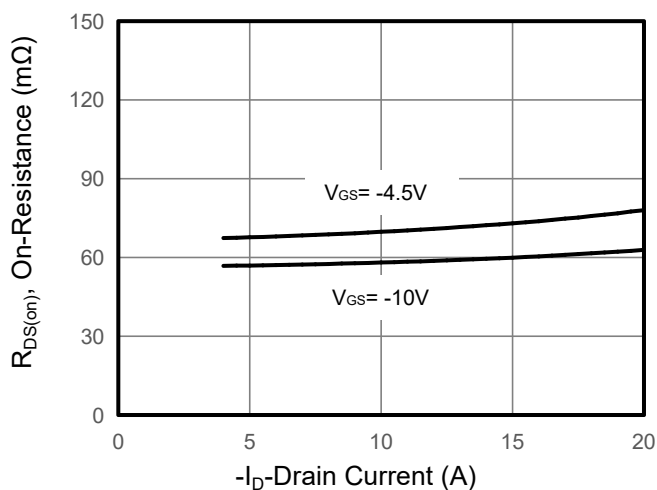


Figure 4. Gate Charge

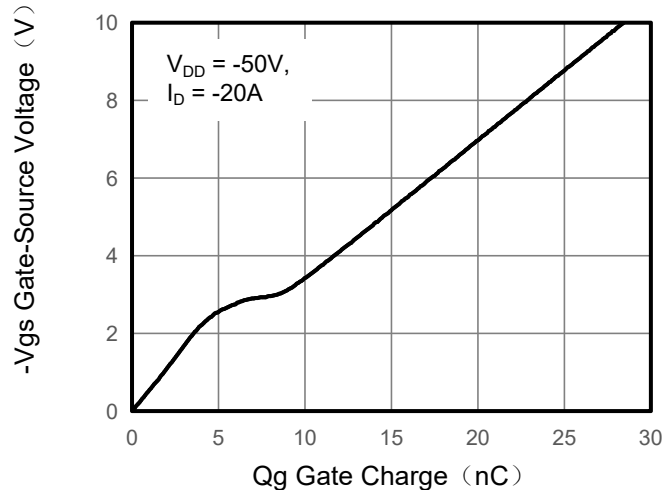


Figure 5. Capacitance

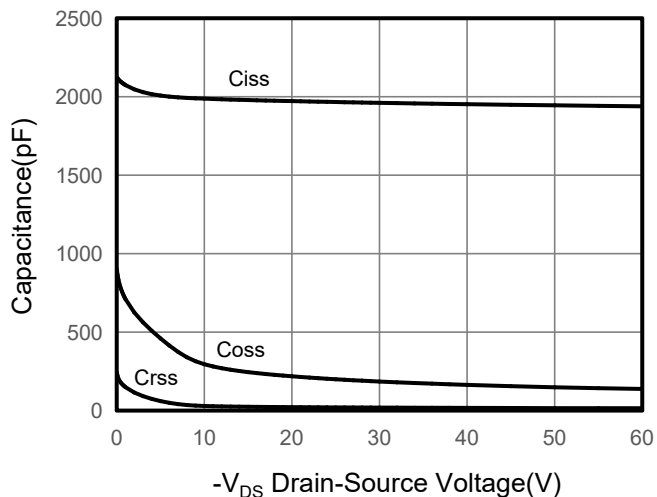
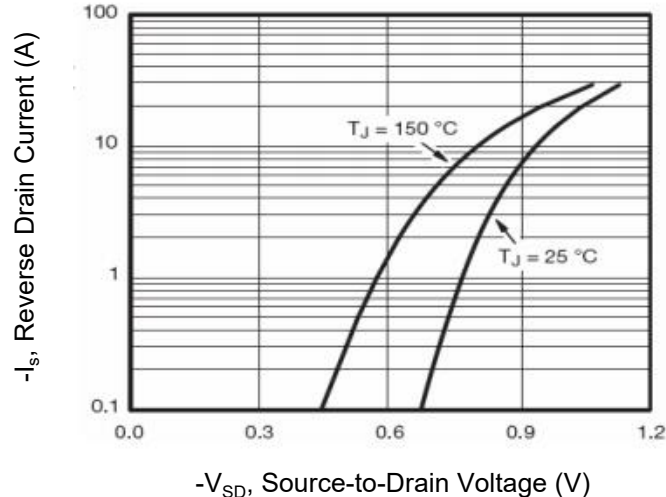


Figure 6. Source-Drain Diode Forward



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

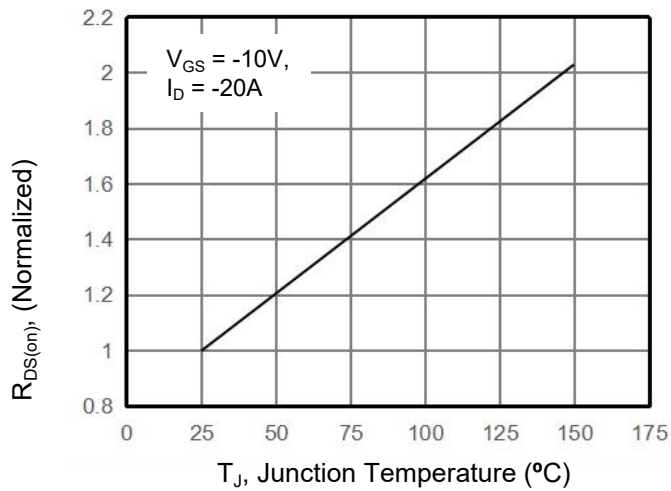


Figure 8. Safe Operation Area

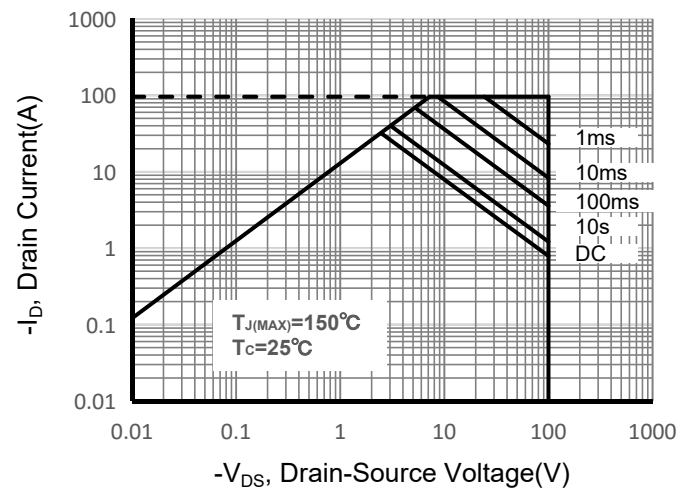


Figure 9. Maximum Continuous Drain Current vs Case Temperature

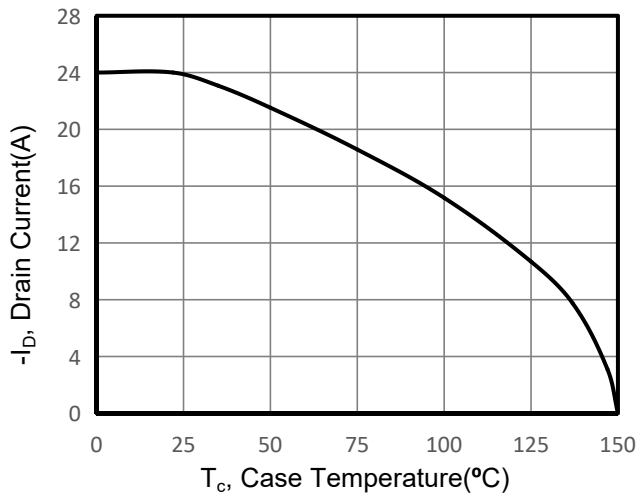
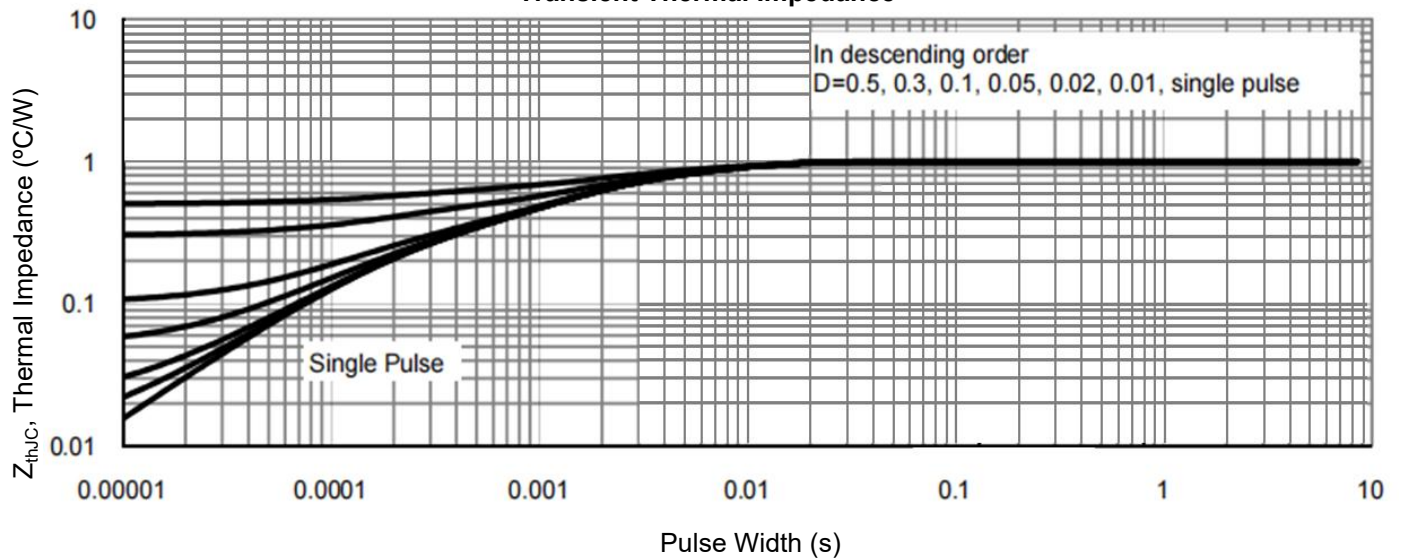
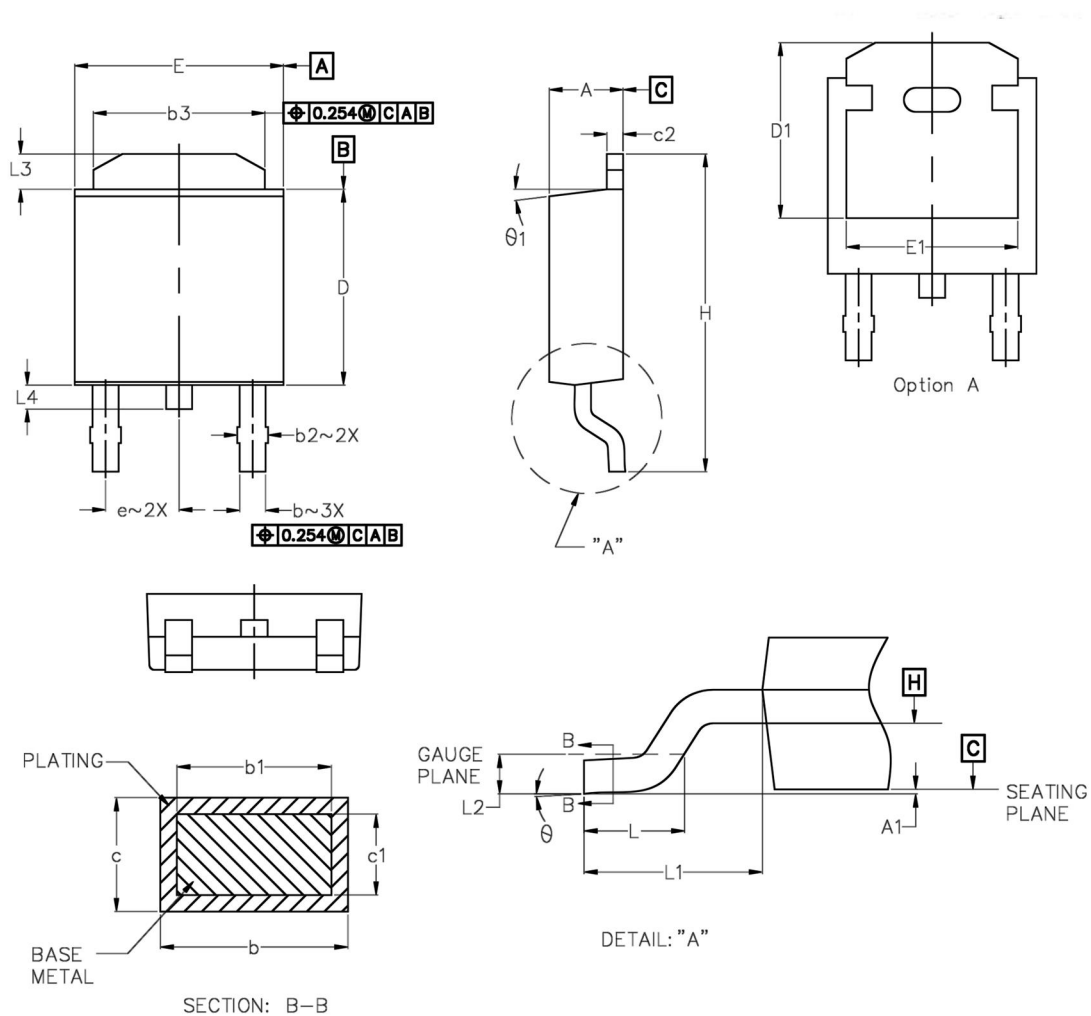


Figure 10. Normalized Maximum Transient Thermal Impedance



TO-252 Package Information



Symbol	COMMON			
	MM		INCH	
	MIN.	MAX.	MIN.	MAX.
A	2.184	2.387	0.086	0.094
A1	—	0.127	—	0.005
b	0.750	0.890	0.029	0.035
b1	0.750	0.860	0.029	0.034
b2	0.762	1.143	0.030	0.045
b3	4.953	5.461	0.195	0.215
c	0.460	0.610	0.018	0.024
c1	0.410	0.559	0.016	0.022
c2	0.460	0.889	0.018	0.035
D	5.969	6.223	0.235	0.245
D1	5.207	—	0.205	—
E	6.350	6.731	0.250	0.265
E1	4.318	—	0.170	—
e	2.290 BSC		0.090 BSC	
H	9.398	10.414	0.370	0.410
L	1.397	1.778	0.055	0.070
L1	2.743 BSC		0.108 BSC	
L2	0.508 BSC		0.020 BSC	
L3	0.889	1.270	0.035	0.050
L4	—	1.016	—	0.040
θ	0°	10°	0°	10°
θ_1	0°	15°	0°	15°